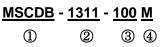
SCOPE :

This specification applies to the Pb Free high current type SMD inductors for MSCDB-1311-SERIES

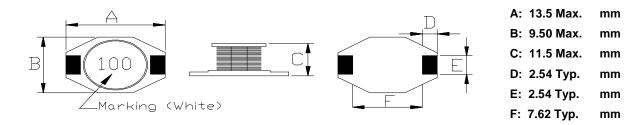
Warn : It is here not to use synchronous rectification curcuit !

PRODUCT INDENTIFICATION



- ① Product Code
- ② Dimensions Code
- **③ Inductance Code**
- **④** Tolerance Code

(1) SHAPES AND DIMENSIONS



(2) ELECTRICAL SPECIFICATIONS

SEE TABLE 1

TEST INSTRUMENTS

- L : HP 4284A PRECISION LCR METER (or equivalent)
- SRF: HP 4291B IMPEDANCE ANALYZER (or equivalent)
- RDC : CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

(3) CHARACTERISTICS

- (3)-1 Ambient temperature +60 $^\circ\!\!\! \mathbb C$ Max.
- (3)-2 Operate temperature range $-40^{\circ}C \sim +125^{\circ}C$ (Including self temp. rise)
- (3)-3 Storage temperature range -40° C ~ $+125^{\circ}$ C



| MAGLAYERS | Inductance | Percent Test | | SRF(MHz) | Resistance | Rated DC Current | | - Marking |
|----------------|------------|--------------|--------------|----------|------------|------------------|---------|-----------|
| PT/NO. | L(µH) | Tolerance | Frequency | Тур. | RDC(Ω)Max. | IDC1(A) | IDC2(A) | Marking |
| MSCDB-1311-1R0 | 1.0 | M,N | 100kHz/0.25V | 100 | 8m | 16 | 10.0 | 1R0 |
| MSCDB-1311-2R2 | 2.2 | N | 100kHz/0.25V | 60 | 18m | 14 | 8.5 | 2R2 |
| MSCDB-1311-3R3 | 3.3 | N | 100kHz/0.25V | 50 | 20m | 12 | 6.5 | 3R3 |
| MSCDB-1311-4R7 | 4.7 | N | 100kHz/0.25V | 35 | 23m | 9.5 | 4.5 | 4R7 |
| MSCDB-1311-100 | 10 | M,N | 100kHz/0.25V | 22 | 33m | 8.0 | 3.5 | 100 |
| MSCDB-1311-150 | 15 | M,N | 100kHz/0.25V | 18 | 42m | 7.0 | 3.0 | 150 |
| MSCDB-1311-220 | 22 | M,N | 100kHz/0.25V | 11 | 54m | 5.5 | 2.5 | 220 |
| MSCDB-1311-330 | 33 | M,N | 100kHz/0.25V | 9 | 80m | 4.0 | 2.0 | 330 |
| MSCDB-1311-470 | 47 | M,N | 100kHz/0.25V | 8 | 0.10 | 3.8 | 1.6 | 470 |
| MSCDB-1311-680 | 68 | M,N | 100kHz/0.25V | 7 | 0.17 | 3.0 | 1.2 | 680 |
| MSCDB-1311-101 | 100 | K,M | 100kHz/0.25V | 5 | 0.22 | 2.5 | 1.2 | 101 |
| MSCDB-1311-151 | 150 | K,M | 100kHz/0.25V | 4 | 0.34 | 2.0 | 0.9 | 151 |
| MSCDB-1311-221 | 220 | K,M | 100kHz/0.25V | 3.5 | 0.44 | 1.6 | 0.7 | 221 |
| MSCDB-1311-331 | 330 | K,M | 100kHz/0.25V | 2.5 | 0.70 | 1.2 | 0.6 | 331 |
| MSCDB-1311-471 | 470 | K,M | 100kHz/0.25V | 2.0 | 0.95 | 1.0 | 0.3 | 471 |
| MSCDB-1311-681 | 680 | K,M | 100kHz/0.25V | 2.0 | 1.20 | 1.0 | 0.2 | 681 |
| MSCDB-1311-102 | 1000 | K,M | 100kHz/0.25V | 1.5 | 2.00 | 0.8 | 0.1 | 102 |

TABLE 1

 \square specify the inductance tolerance,K(±10%),M(±20%),N(±30%)

IDC1 : Based on inductance change (Δ L/Lo : drop 10% Max.) @ambient temperature 25 $^{\circ}$ C

IDC2 : Based on temperature rise ($\triangle T$: 40°C TYP.)

Rated DC Current : The less value which is IDC1 or IDC2.



(4) RELIABILITY TEST METHOD

MECHANICAL

| TEST ITEM | SPECIFICATION | TEST DETAILS | | | | |
|-------------------|-----------------|-------------------------------------------------------------------------------------|--|--|--|--|
| Substrate bending | ∆L/Lo≦±5% | The sample shall be soldered onto the printed circuit board | | | | |
| | | in figure 1 and a load applied unitil the figure in the arrow | | | | |
| | There shall be | direction is made approximately 3mm.(keep time 30 seconds) | | | | |
| | no mechanical | PCB dimension shall the page 7/9 | | | | |
| | damage or elec- | F(Pressurization) | | | | |
| | trical damege. | | | | | |
| | | R5 45±2 45±2 | | | | |
| | | PRESSURE ROD figure-1 | | | | |
| Vibration | ∆L/Lo≦±5% | The sample shall be soldered onto the printed circuit board | | | | |
| | | and when a vibration having an amplitude of 1.52mm | | | | |
| | There shall be | and a frequency of from 10 to 55Hz/1 minute repeated should | | | | |
| | no mechanical | be applied to the 3 directions (X,Y,Z) for 2 hours each. | | | | |
| | damage. | (A total of 6 hours) | | | | |
| Solderability | New solder | Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated | | | | |
| Solderability | More than 90% | over the whole of the sample before hard, the sample shall | | | | |
| | | then be preheated for about 2 minutes in a temperature of | | | | |
| | | 130 \sim 150 $^\circ\!\mathrm{C}$ and after it has been immersed to a depth 0.5mm | | | | |
| | | below for 3±0.2 seconds fully in molten solder M705 with | | | | |
| | | a temperature of 245±5℃. | | | | |
| | | More than 90% of the electrode sections shall be couered | | | | |
| | | with new solder smoothly when the sample is taken out of | | | | |
| | | the solder bath. | | | | |
| | | | | | | |



MECHANICAL

| TEST ITEM | SPECIFICATION | | | | | | |
|--------------------------------------------------------------------|---------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|--|--|--|
| TEST ITEM Resistance to Soldering heat (reflow soldering) | There shall be no damage or problems. | Temperature profile of reflow soldering $300 - \frac{300}{250} + \frac{300}{200} + \frac{300}{20$ | | | | | |
| | | | | | | | |

ELECTRICAL

| TEST ITEM | SPECIFICATION | TEST DETAILS | | | | |
|------------------------------|----------------|------------------------------------------------------------------------------------|--|--|--|--|
| Dielectric | There shall be | AC 100V voltage shall be applied for 1 minute acrosset the top | | | | |
| withstand | no other | surface and the terminal of this sample | | | | |
| voltage | damage or | | | | | |
| | problems. | | | | | |
| Temperature | ∆L/L20℃ ≦±10% | The test shall be performed after the sample has stabilized in | | | | |
| characteristics 0∼2000 ppm/℃ | | an ambient temperature of -20 to +85 $^\circ\!\!{ m C}$,and the value | | | | |
| | | calculated based on the value applicable in a normal | | | | |
| | | temperature and narmal humidity shall be $	riangle L/L20^{\circ}C \leq \pm 10\%$. | | | | |
| | | | | | | |
| | | | | | | |
| | | | | | | |



ENVIROMENT CHARACTERISTICS

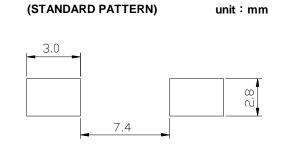
| TEST ITEM | | | | SPECIFICATION | | | | |
|-------------------|------------------------|------------------------------------------------------------------------------------------|------------------------------------------------------------------|---------------------------|------------------------|--|--|--|
| High temperature | ∆L/Lo≦±5% | \triangle L/Lo \leq ±5% The sample shall be left for 96±4 hours in an atmospere with | | | | | | |
| storage | | a tempe | a temperature of 85±2 $^\circ\!\!{ m C}$ and a normal humidity. | | | | | |
| | There shall be | Upon co | Upon completion of the measurement shall be made after the | | | | | |
| | no mechanical | sample | sample has been left in a normal temperature and normal | | | | | |
| | damage. | humidit | humidity for 1 hour. | | | | | |
| | | | | | | | | |
| Low temperature | ∆L/Lo≦±5% | The sample shall be left for 96±4 hours in an atmosphere with | | | | | | |
| storage | | a tempe | a temperature of -25±3℃. | | | | | |
| | There shall be | Upon co | Upon completion of the test, the measurement shall be made | | | | | |
| | no mechanical | after the | after the sample has been left in a normal temperature and | | | | | |
| | damage. | normal | normal humidity for 1 hour. | | | | | |
| Change of | ∆L/Lo≦±5% | The san | The sample shall be subject to 5 continuos cycles, such as shown | | | | | |
| temperature | | in the ta | in the table 2 below and then it shall be subjected to standard | | | | | |
| | There shall be | atmosp | atmospheric conditions for 1 hour, after which measurement | | | | | |
| | no other dama- | shall be | shall be made. | | | | | |
| | ge of problems | | | | | | | |
| | | table 2 | | | | | | |
| | | | | Temperature | Duration | | | |
| | | | 1 | − 25±3° C | 30 min. | | | |
| | | | | (Themostat No.1) | | | | |
| | | | 2 | Standard | No.1→No.2 | | | |
| | | | | atmospheric | 10.1 110.2 | | | |
| | | | 3 | 85±2℃ | 30 min. | | | |
| | | | | (Themostat No.2) | | | | |
| | | | 4 | Standard | No.2→No.1 | | | |
| | | | | atmospheric | | | | |
| Moisture storage | ∆L/Lo≦±5% | The san | nple s | hall be left for 96±4 hou | rs in a temperature of | | | |
| | | 40±2℃ | $40\pm2^{\circ}_{\circ}$ and a humidity(RH) of 90~95%. | | | | | |
| | There shall be | Upon co | Upon completion of the test, the measurement shall be made | | | | | |
| | no mechanical | after the | after the sample has been left in a normal temperature and | | | | | |
| | damage. | normal humidity more than 1 hour. | | | | | | |
| Test conditions : | | 1 | | | | | | |
| The | sample shall be reflow | w soldered | l onto | the printed circuit boar | d in every test. | | | |
| | | | | | | | | |



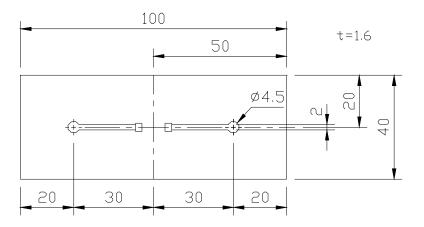
(5) LAND DIMENSION (Ref.)

PCB: GLASS EPOXY t=1.6mm

(5)-1 LAND PATTERN DIMENSIONS

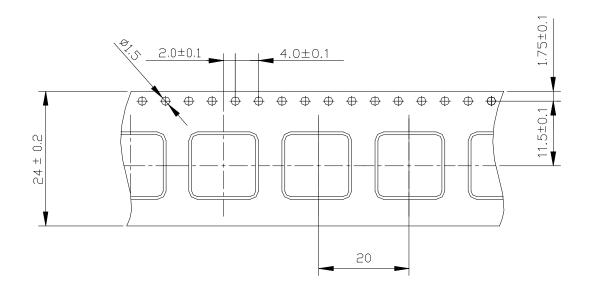


(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD



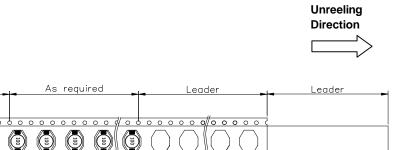


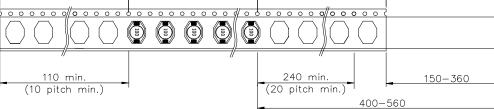
(6) PACKAGING (6)-1 CARRIER TAPE DIMENSIONS (mm)



(6)-2 TAPING DIMENSIONS (mm)

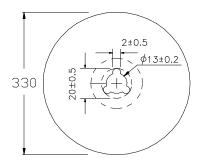
Trailer

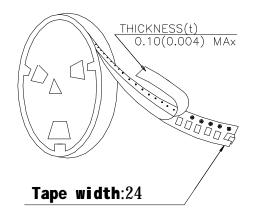






(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

250pcs/Reel

The products are packaged so that no damage will be sustained.

